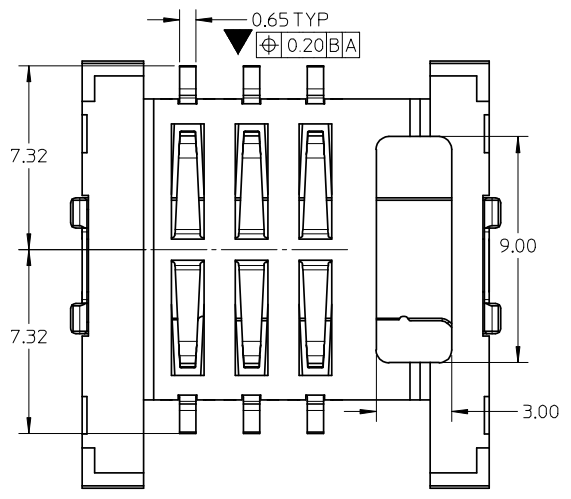
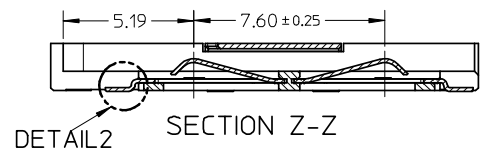
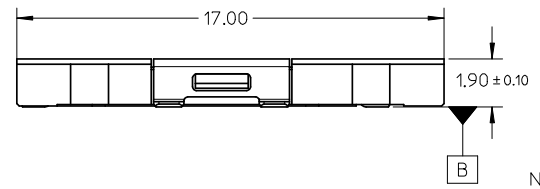
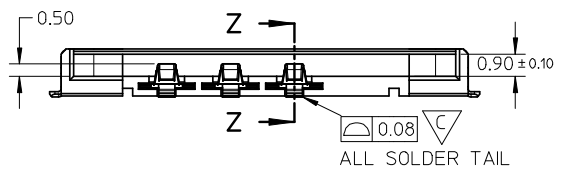


RECOMMENDED PCB LAYOUT
DIMENSIONS GENERAL TOLERANCE : ±0.05



NOTE:
 1 MATERIAL: HOUSING: LCP, GLASS FILLED, UL 94V-0, COLOR:BLACK,
 TERMINAL: PHOSPHOR BRONZE, THICKNESS:0.15MM
 SHELL: STAINLESS STEEL, THICKNESS:0.20MM
 2 FINISH: TERMINAL: 50 μ MIN NICKEL PLATING OVER ALL.
 15μ MIN GOLD PLATING ON CONTACT AREA
 GOLD FLASH PLATING ON SOLDER AREA
 SHELL: GOLD FLASH OVER 50 μ MIN NICKEL ON SOLDERING AREA
 3 PRODUCT SPECIFICATION: PS-47548-001
 4 PACKAGE INFORMATION: PK-47548-001

RELEASED EC NO: SH2008-0563 DRWN: YWANG91 CHKD: YI ZHU APPR: HWANG	QUALITY SYMBOLS ▽=1 C=1	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY	SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION															
		<table border="1"> <tr> <th></th> <th>mm</th> <th>INCH</th> </tr> <tr> <td>4 PLACES</td> <td>± ---</td> <td>± ---</td> </tr> <tr> <td>3 PLACES</td> <td>± ---</td> <td>± ---</td> </tr> <tr> <td>2 PLACES</td> <td>± 0.15</td> <td>± ---</td> </tr> <tr> <td>1 PLACE</td> <td>± ---</td> <td>± ---</td> </tr> </table>		mm	INCH	4 PLACES	± ---	± ---	3 PLACES	± ---	± ---	2 PLACES	± 0.15	± ---	1 PLACE	± ---	± ---	DRAWN BY YWANG	DATE 2007/01/16	TITLE ASSEMBLY SIM CARD CONNECTOR 1.9MM HEIGHT		
			mm	INCH																		
		4 PLACES	± ---	± ---																		
3 PLACES	± ---	± ---																				
2 PLACES	± 0.15	± ---																				
1 PLACE	± ---	± ---																				
ANGULAR ± 1 °	APPROVED BY JNCHEN	DATE 2007/01/18	MOLEX INCORPORATED																			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	MATERIAL NO. 475480001	DOCUMENT NO. SD-47548-001	SHEET NO. 1 OF 1																			